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Interface engineering and oxygen vacancies derived from plasma-treated Cu₂O synergistically enhancing electrocatalytic CO₂-to-C₂₊ conversion†

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Electrocatalytic CO₂ reduction (ECR) into value-added chemicals and fuels helps tackle the challenges of the energy crisis and global warming. However, this strategy relies heavily on the rational design of catalysts with high selectivity and activity towards C₂₊ products. Herein, we introduce a dual-engineering strategy using plasma-treated Cu₂O to synergistically enhance the material's catalytic performance for CO₂-to-C₂₊ conversion. We demonstrate that well-controlled plasma reduction treatment in an Ar/H₂ atmosphere can yield stable Cu₂O–Cu catalysts (Cu₂O–Ar/H₂) with Cu⁰/Cu⁺ interfaces, abundant grain boundaries, and a high density of oxygen vacancies. Cu₂O–Ar/H₂ delivers an impressive 81.2% faradaic efficiency for C₂₊ products at an industrial current density of 100 mA cm⁻². Performance comparisons show that plasma pre-reduction treatment samples outperform the *in situ* reduced Cu₂O sample during ECR. Theoretical calculations reveal that the well-defined Cu⁰/Cu⁺ interfaces optimize intermediate adsorption and the oxygen vacancies provide multiple active sites for C–C coupling. This work establishes a correlation between plasma treatment-generated active sites and high C₂₊ product selectivity. Our work also demonstrates that this facile, scalable, standardized and controllable material preparation method can effectively promote the large-scale application of high-activity ECR catalysts.

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1 Introduction

Electrocatalytic CO₂ reduction (ECR) into high-value chemicals and feedstocks using renewable electricity offers an elegant solution for closing the carbon cycle, addressing global environmental issues, and meeting growing energy demands.^{1,2}

However, the potential of this technology heavily relies on the development of highly active and selective electrocatalysts.^{3,4} Although other metals such as Ag and Sn have achieved highly selective C₁ products, such as CO and formate,^{5,6} achieving high selectivity for C₂₊ products on Cu-based catalysts remains highly challenging due to their sluggish multiple proton-coupled electron transfer (PCET) processes in C–C coupling and the competitive hydrogen evolution reaction (HER).⁷ Therefore, there is an urgent need to develop highly efficient and active catalysts with scalable synthesis methods that can enhance selectivity towards C₂₊ products.

To enhance ECR to C₂₊ conversion selectivity, substantial efforts have focused on the rational design of copper-based catalysts, including morphology,⁸ oxide-derived copper (OD-Cu),⁹ interfacial structures,^{10,11} and alloying^{12,13} strategies. In particular, OD-Cu has been reported with excellent C₂₊ selectivity,⁴ garnering widespread research interest. However, for OD-Cu, the active Cu⁺ species inevitably undergoes electrochemical reduction to bulk metallic Cu at high current densities,¹⁴ leading to poor selectivity for C₂₊ products. This poses a significant challenge for the effective utilization of OD-Cu. Thus, unconventional and feasible strategies for stabilizing the active Cu⁺ species at reduction potentials during actual CO₂

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reduction processes is necessary. Research results indicate that abundant nanograin boundaries can enhance the stability of catalyst morphology and Cu⁰/Cu⁺ interfaces at high polarization and high current density, preventing catalyst reconstruction and improving the catalytic stability.¹⁵ Moreover, nanograin boundaries and the Cu⁰/Cu⁺ interface can increase *CO adsorption strength, promoting CO–CO coupling toward C₂₊ products.^{16,17} Therefore, constructing intricate structures assembled with abundant nanograin boundaries and Cu⁰/Cu⁺ interfaces in Cu-based catalysts is promising for achieving efficient ECR to C₂₊ products.

In addition, oxygen vacancies, as a well-known defect, are widely employed to tailor the properties of catalysts.^{18–20} For example, due to their weakly bound electrons, oxygen vacancies serve as excellent Lewis base sites to enhance the binding affinities of key intermediates (such as *CO and *COH), thereby promoting the production of C₂.²¹ Moreover, a higher concentration of oxygen vacancies near the active sites is favorable for activating CO₂ molecules, lowering the reaction barrier for targeted products.²² Therefore, integrating oxygen vacancies with grain boundaries and interface engineering is likely to modulate the surface electronic structure and concentration of active sites, accelerating reaction kinetics. However, effectively constructing oxygen vacancies and interface structures on the catalyst surface is highly challenging. A deeper understanding of the synergistic interaction between oxygen vacancies and interface structures will provide valuable guidance for the rational design of catalysts.

Plasma treatment, as a facile and scalable technique, has been introduced to selectively activate catalysts, due to its ability to rapidly alter the surface chemical state of catalysts at room temperature,²³ create defect structures,²⁴ or embed heteroatoms²⁵ to improve reactivity. For example, Cu surfaces treated with O₂ plasma exhibit higher ethylene selectivity than those treated with H₂ plasma. The activity enhancement may originate from the presence of Cu⁺.²⁶ Cuenya's group reported that O₂ plasma treatment gives rise to specific defect sites and stable subsurface oxygen species inside Cu nanocubes, which are key to achieving high activity and ethylene selectivity.²⁷ Additionally, Kang's group indicated that oxygen-plasma-assisted nitrogen doping on CuO can achieve high C₂₊ product selectivity, with enhanced activity attributed to the oxygen vacancies and grain boundary defects generated by N₂ plasma radicals on CuO.²⁴ These studies suggest that plasma treatment, as an effective surface treatment method, can precisely control active sites under different atmospheres.^{28,29} Nevertheless, whether plasma treatment can be used to synergistically construct oxygen vacancies and Cu⁺/Cu⁰ interface structures on the metal oxide catalyst surface has yet to be investigated.

In this study, we employ plasma treatment under different atmospheres as a dual-engineering strategy to couple oxygen vacancies and interface structures, aiming to enhance the activity of the ECR catalysts. Plasma treatment in an Ar/H₂ environment results in the reduction of grain-boundary-rich Cu₂O, creating active interfaces of Cu⁰/Cu⁺ interface structures and abundant oxygen vacancies. Compared to original Cu₂O and Cu₂O treated under an Ar/O₂ atmosphere (Cu₂O–Ar/O₂), the

coordinated interaction between Cu⁰/Cu⁺ and oxygen vacancies from Cu₂O–Ar/H₂ contributes to enhanced catalytic activity for C₂₊ products. DFT calculations indicate that Cu₂O–Ar/H₂ is more favorable for *OHCCO intermediate adsorption, promoting the conversion of C₂₊ products. As a result, the Cu₂O–Ar/H₂ sample achieves a faradaic efficiency of 81.4% for C₂₊ products at a current density of 100 mA cm⁻². This study reveals the mechanism by which plasma treatment enhances catalyst activity, advancing the development of ECR to C₂₊ products.

2 Experimental section

2.1 Materials

A Cu₂O target was purchased from AJA International Inc, USA. Potassium hydroxide (KOH) and ultrapure water (18 MΩ cm) were obtained from the University of Waterloo Chemical Store. Carbon paper (Freudenberg H15C13) and a Fumasep FAB-PK-130 membrane were purchased from a fuel cell store, USA. Argon and CO₂ gas were provided by Linde Gas, Canada.

2.2 Synthesis of electrocatalysts

2.2.1 Synthesis of Cu₂O nanostructures. The carbon paper was cut into pieces of size 6 cm × 4 cm and then gently (low power) sonicated in acetone and IPA for 5 minutes each to remove any unbound materials or surface impurities. The substrates were then dried with an N₂ blower and heated at 80 °C for 30 minutes to remove any solvent residue. After that, Cu₂O was sputter-deposited on the substrates. For sputtering, the base pressure of the deposition chamber was ~2 × 10⁻⁷ torr, and the Cu₂O target was pre-sputtered for 30 min at 200 W. After that, the clean substrates were soaked at 70 °C for 30 minutes inside the deposition chamber and then sputtered for 90 minutes at 200 W power (DC bias: 380 V), keeping the Ar and O₂ flow fixed at 12 sccm and 0.3 sccm, respectively with a 3 mTorr chamber pressure during deposition.

2.2.2 Plasma treatment. The substrates were again cut into small pieces of size 2 cm × 2 cm and then treated with two different plasmas under different atmospheres, keeping all other parameters the same. For plasma treatment, the chamber was flushed with Ar gas three times before each treatment, and the chamber pressure was maintained at 100 mTorr and with an RIE and ICP power of 100 W each. Two different plasmas were created as per the set parameters with different gas flows as follows: O₂ plasma: O₂ flow 45 sccm, Ar flow 5 sccm; and H₂ plasma: H₂ flow 15 sccm, Ar flow 35 sccm.

2.3 Ex situ material characterization

Scanning electron microscopy (SEM, Hitachi S4800, Japan) images were taken with a working accelerating voltage of 10 kV. Glancing-incidence X-ray diffraction (GIXRD) spectra were collected on a MRD diffractometer (PANalytical X'Pert Pro, Netherlands) with Cu Kα radiation (1.54 Å) at an incidence angle of 0.3°. X-ray photoelectron spectroscopy (XPS) measurements were conducted (Thermo-VG Scientific ESCALab 250, USA) using microprobes with a monochromatic Al Kα X-ray

source (1486.6 eV). High resolution TEM images (Zeiss Libra 200 MC, German) were collected with an acceleration voltage of 200 kV. The XAS measurements were conducted at the 06ID-1 Hard X-ray MicroAnalysis (HXMA) beamline of the Canadian Light Source (CLS) operated at 2.9 GeV with a constant current of 220 mA. The measurements at the copper K-edge were performed in fluorescence mode using a Ge detector. Proton nuclear magnetic resonance (H-NMR) spectroscopy was run on a Bruker Avance III 500 MHz, USA. The reduced products were evaluated on a gas chromatograph (Shimadzu, GC-2014) with a Carbonxen® 1000 column and a CarbonPLOT column for a flame ionization detector (FID) and thermal conductivity detector (TCD), respectively.

2.4 Electrochemical measurements

For the ECR test, all electrochemical tests were performed using an electrochemical workstation (Gamry Reference 3000) with *iR* compensation at room temperature. The performance evaluation of electrochemical CO₂ reduction is conducted in flow cell setups. A prepared sample on carbon paper, Ni foam, and Ag/AgCl are used as the working electrode, counter electrode, and reference electrode, respectively. A gas-tight three-chamber flow cell is equipped with a Fumasep FAB-PK-130 anion exchange membrane (AEM), and 1 M KOH serves as the cathode and anode circulating electrolyte with a flow rate of 18 mL min⁻¹. The flow rate of CO₂ gas is set to 30 sccm. The ECR catalytic activities were evaluated using the potentiostatic technique for 1000 s. The gas products were analyzed using a Shimadzu GC-2014, while the liquid products were characterized using a Bruker 500 MHz Nuclear Magnetic Resonance (NMR) spectrometer with an internal reference prepared with D₂O and DMSO.

All potentials in this work were measured against the Ag/AgCl reference electrode and converted into reversible hydrogen potential (RHE) using the equation below:

$$E(\text{vs. RHE}) = E(\text{vs. Ag/AgCl}) + 0.059 \times \text{pH} + 0.197$$

All the potentials are relative to the RHE unless stated otherwise.

2.5 DFT calculation details

All calculations were performed using the Vienna *ab initio* simulation package with the Perdew–Burke–Ernzerhof (PBE) generalized gradient approximation (GGA) exchange–correlation functional.³⁰ A plane wave cutoff energy of 450 eV was employed. Spin polarization and van der Waals corrections in the models were accounted for using the projector augmented wave (PAW)³¹ method and DFT-D3,³² respectively. The convergence criteria for the total energy and forces were set to 1 × 10⁻⁵ eV and 0.03 eV Å⁻¹, respectively. The *k*-point sampling was performed using a 3 × 3 × 1 gamma scheme. A vacuum layer of 15 Å was introduced to eliminate interactions between the layers in the model. A three-layer Cu₂O (111) surface was constructed to model the Cu₂O sample, where the oxygen vacancy

on the Cu₂O (111) surface is represented by removing a coordinated oxygen atom (Fig. S11a†). The Cu₂O (111)/Cu (111) structure was obtained by adding two layers of Cu (111) under the Cu₂O (111) surface, a four-layer slab model, to model the Cu₂O–Ar/H₂ sample (Fig. S11b†). The VASPsol implicit solvation model was used to study the solvation effect.³³ As shown in Table S3†, taking two key intermediates of the potential-determining steps, *CO and *CHO, as examples, there is little difference in the reaction energies considering the solvation effect or not, and consequently the solvation effect is not considered.

3 Results and discussion

3.1 Synthesis and *ex situ* characterization of electrocatalysts

The material preparation process, involving both magnetron sputtering and plasma treatment, is illustrated in Fig. 1a. Initially, Cu₂O catalysts are fabricated on a gas diffusion electrode (GDE) *via* magnetron sputtering using a Cu₂O target. Subsequently, plasma treatments on Cu₂O catalysts are conducted under reducing (Ar/H₂) and oxidizing (Ar/O₂) atmospheres, wherein highly reactive Ar/H₂ and Ar/O₂ active particles in the plasma state bombard the surface of Cu₂O, causing further reduction or oxidation. This would create different structural defects in the resulting Cu₂O–Ar/H₂ and Cu₂O–Ar/O₂. This facile and scalable material preparation method makes it feasible to produce large-scale gas diffusion electrode (GDE)-compatible high-activity ECR catalysts.

The composition and structural characteristics of the synthesized samples were investigated using grazing incidence X-ray diffraction (GIXRD). Diffraction peaks attributed to cuprite (Cu₂O JCPDF#05-0667) are observed in the Cu₂O and Cu₂O–Ar/O₂ samples (Fig. 1b), indicating that Ar/O₂ plasma treatment does not reduce the original Cu₂O. However, the mixed phase of Cu (JCPDF#04-0836) and Cu₂O in the Cu₂O–Ar/H₂ sample suggests that Ar/H₂ plasma treatment partially reduced Cu₂O to metallic copper (Fig. 1b), forming interface structures between Cu and Cu₂O. The scanning electron microscope (SEM) images reveal that Cu₂O nanoparticles are *in situ* grown on carbon paper using magnetron sputtering (Fig. S1a and b†). The Ar/H₂ (Fig. 1c, d, S1c and d†) and Ar/O₂ (Fig. S1e and f†) plasma treatments do not visibly affect the morphology of Cu₂O NPs. SEM-EDS elemental mapping images show a uniform distribution of Cu and O in the Cu₂O (Fig. S2a†) and Cu₂O–Ar/O₂ (Fig. S2b†) samples, while SEM-EDS images (Fig. 1e) confirm that Ar/H₂ plasma treatment does not completely reduce Cu₂O to Cu, as oxygen signals are still detected. Correspondingly, in terms of elemental composition, compared to pristine Cu₂O (Fig. S4†), the oxygen content in Cu₂O–Ar/H₂ (Fig. S3†) is significantly reduced, while the oxygen content in Cu₂O–Ar/O₂ (Fig. S5†) remains relatively unchanged. High-resolution transmission electron microscopy (HRTEM) images reveal the presence of abundant grain boundary structures in the as-synthesized samples (Fig. 1f and g). For the original Cu₂O, lattice spacings of 0.29 nm and 0.24 nm are attributed to the (110) and (111) planes of Cu₂O³⁴ (Fig. 1f and S6a and b†), respectively. However, after plasma

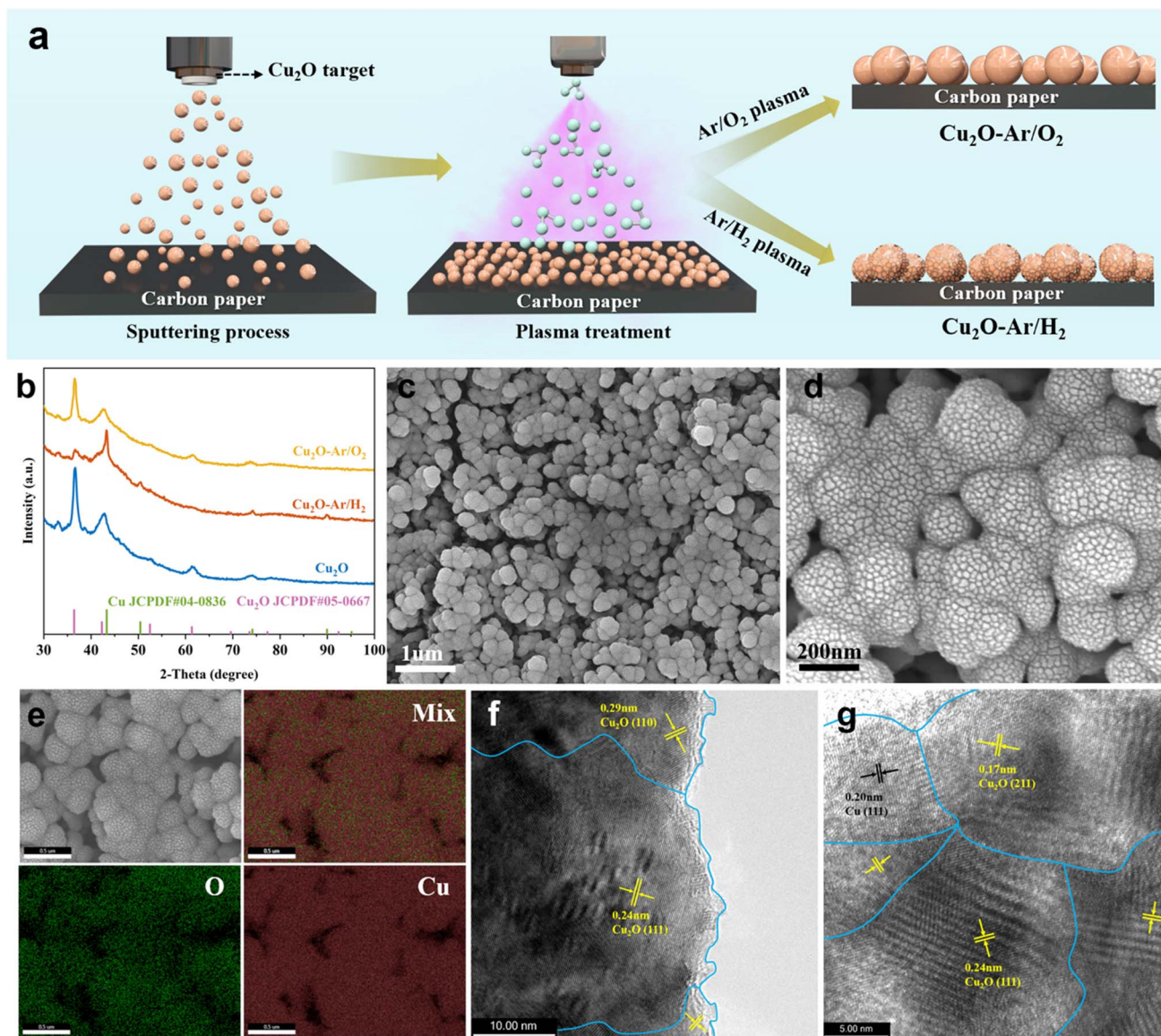


Fig. 1 Synthesis and structural characterization of electrocatalysts. (a) The schematic illustration of the as-synthesized catalysts. (b) GIXRD spectra of the as-prepared electrocatalysts; (c and d) SEM images of $\text{Cu}_2\text{O}-\text{Ar}/\text{H}_2$; (e) SEM-EDS elemental mapping images of $\text{Cu}_2\text{O}-\text{Ar}/\text{H}_2$; (f and g) HRTEM images of Cu_2O (f) and $\text{Cu}_2\text{O}-\text{Ar}/\text{H}_2$ (g).

reduction treatment on the $\text{Cu}_2\text{O}-\text{Ar}/\text{H}_2$ sample, the grain boundary structures observed at 0.17 nm for Cu_2O (211), 0.20 nm for Cu (111), and 0.24 nm for Cu_2O (111) indicate the existence of Cu^0/Cu^+ interface structures^{35,36} (Fig. 1g and S7a†). This suggests that partial reduction of Cu atoms in Cu_2O nanoparticles has occurred under plasma reduction treatment, forming an interface between Cu^0 and Cu^+ within the Cu_2O lattice. Such interface structures may facilitate the formation of active sites and the generation of oxygen vacancies, thereby enhancing catalytic performance. In contrast, for the $\text{Cu}_2\text{O}-\text{Ar}/\text{O}_2$ sample, only the grain boundary structures of Cu_2O (111) and (110) are observed, with no presence of metallic Cu (Fig. S7b†). This indicates that the plasma oxidation process does not create the unique interface structure seen in the $\text{Cu}_2\text{O}-\text{Ar}/\text{H}_2$ sample.

X-ray photoelectron spectroscopy (XPS) was used to reveal changes in surface composition and chemical states of Cu_2O samples treated with plasma under different reaction atmospheres. For the Cu_2O and $\text{Cu}_2\text{O}-\text{Ar}/\text{H}_2$ samples, the Cu 2p XPS spectrum can be deconvoluted into two peaks at 932.4 and 933.9 eV, corresponding to Cu^+/Cu^0 and Cu^{2+} species^{21,37} (Fig. S8†), respectively. However, compared to the samples treated with Ar/H_2 plasma reduction, those treated with Ar/O_2 plasma only exhibit features of Cu^{2+} species (Fig. S8†), indicating that the surface Cu_2O has been further oxidized. The Cu Auger LMM spectrum is employed to further confirm the valence state of the Cu species. For the original Cu_2O sample, the surface Cu is mainly in the monovalent and divalent Cu species.³⁸ After plasma reduction treatment, some of the surface Cu is reduced to metallic Cu,³⁹ showing the coexistence of zero-valent,

monovalent, and divalent Cu species (Fig. 2a). For Cu₂O and Cu₂O–Ar/H₂, CuO originates from the inevitable oxidation of Cu species when exposed to air. Nevertheless, for Cu₂O–Ar/O₂, the presence of divalent copper on the surface results from the plasma oxidation treatment (Fig. 2a). Regarding the O 1s XPS spectrum, every O 1s curve is asymmetric and can be fitted into three components: lattice oxygen from Cu₂O (O_L(Cu⁺)) at 530.3 eV or CuO (O_L(Cu²⁺)) at 529.5 eV,⁴⁰ adsorbed oxygen (O_{ad}) at 531.5 eV, and adsorbed water (H₂O_{ad}) at 533.5 eV^{41,42} (Fig. 2b). The ratio between O_{ad} and O_L can be used to evaluate the amount of surface oxygen vacancies.⁴³ It can be observed that the oxygen vacancy content follows this order: Cu₂O–Ar/H₂ (3.95) > Cu₂O (2.54) > Cu₂O–Ar/O₂ (0.97), indicating that Cu₂O–Ar/H₂ has a higher density of surface oxygen vacancies compared to its other two counterparts.

Synchrotron-based X-ray absorption Near-Edge Structure (XANES) spectra and Extended X-ray Absorption Fine Structure (EXAFS) spectra were recorded to further study the chemical state and local coordination environment of copper sites. Compared to Cu₂O and CuO references, the XANES spectra of the as-synthesized samples display characteristics of Cu₂O (Fig. 2c). Although plasma reduction or oxidation treatments could affect the oxidation state of surface Cu atoms, the bulk phase of the catalysts retains attributes of Cu₂O. On the other

hand, fitting in the *R*-space of EXAFS spectra of the as-prepared samples was then conducted to quantify changes in scattering paths (Fig. 2d and Table S1†). For the original Cu₂O sample, a Cu–O coordination number of 1.90 at 1.84 Å and Cu–Cu coordination number of 13.1 at 3.01 Å can be observed, similar to the Cu₂O reference, indicating the characteristic properties of Cu₂O. After plasma reduction or oxidation treatment, different Cu–O coordination numbers of 1.77 at 1.79 Å for Cu₂O–Ar/H₂ and 1.65 at 1.84 Å for Cu₂O–Ar/O₂ can be obtained, indicating that plasma treatment results in structural changes around Cu. For Cu₂O–Ar/H₂, the reduced Cu–O coordination number and similar Cu–Cu coordination number compared to the Cu₂O reference indicate the presence of oxygen vacancies. A wavelet transform was employed to elucidate the coordination environment near the Cu atoms and confirm the atomic distribution of Cu in all samples. As shown in Fig. 2e, for the Cu₂O reference, a strong wavelet transform signal focused at around 5 Å⁻¹ originating from Cu–O coordination is observed, while another intense signal at the same focus can be attributed to Cu–Cu coordination. The wavelet transform contour plot of the CuO reference exhibits only Cu–O coordination features (Fig. S9a†). In contrast, the original Cu₂O sample exhibits similar peak intensities and positions to the Cu₂O reference (Fig. S9b†), indicating their resemblance in structures.

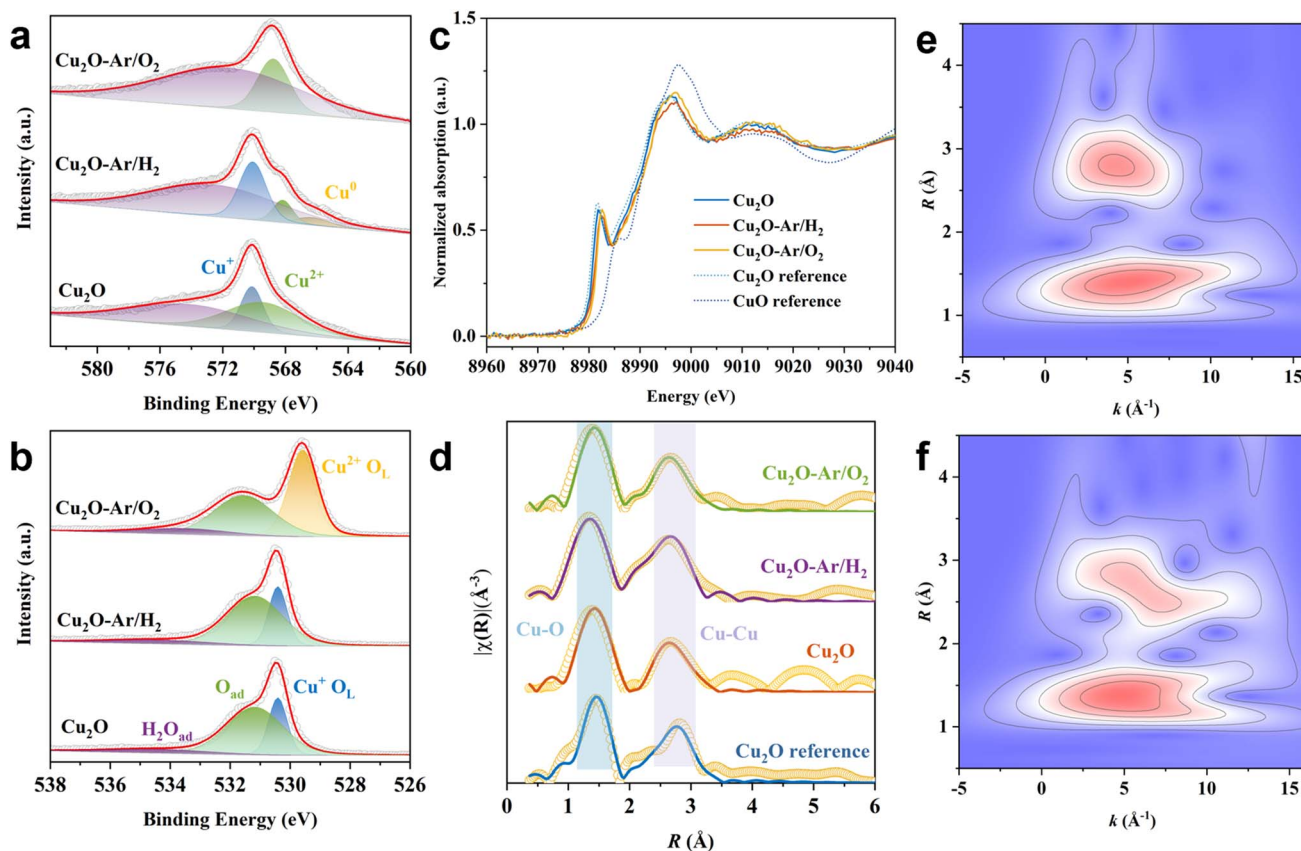


Fig. 2 *Ex situ* X-ray spectroscopic analysis of electrocatalysts. (a and b) Cu LMM Auger spectra (a) and O 1s XPS spectra (b) of the as-prepared catalysts; (c) Cu K-edge XANES spectra of Cu₂O, Cu₂O–Ar/H₂ and Cu₂O–Ar/O₂ samples and corresponding references (Cu₂O, and CuO). (d) Cu K-edge EXAFS experimental and fitting spectra of Cu₂O, Cu₂O–Ar/H₂ and Cu₂O–Ar/O₂ catalysts and corresponding references (Cu₂O). (e and f) Wavelet transforms for the *k*³-weighted EXAFS signals of Cu₂O reference (e) and Cu₂O–Ar/H₂ (f).

However, after plasma reduction or oxidation treatment, differing first shell Cu–O and second shell Cu–Cu scattering distributions suggest variations in the local coordination environment around Cu between Cu₂O–Ar/H₂ and Cu₂O–Ar/O₂ (Fig. 2f vs. Fig. S9c†).

3.2 Electrochemical CO₂ reduction performance

The ECR performance of the as-synthesized catalysts was evaluated in a flow cell using an alkaline electrolyte (1 M KOH). All catalysts exhibit a similar reduced product distribution, with CO, methane, and formic acid as the main C₁ products and ethylene, ethanol, acetic acid, and isopropanol as the main C₂₊ products (Fig. 3a, S10a and b†). For all samples, the H₂ FE increases with increasing cathodic potentials, suggesting that at higher negative potentials, the competitive hydrogen evolution reaction (HER) suppresses the production of C₂₊ products. Therefore, all samples demonstrate higher C₂₊ product selectivity at lower potentials (–0.65 or –0.7 V_{RHE}). The Cu₂O sample shows a relatively high C₂₊ FE (70.47%) at –0.65 V_{RHE}, but as the potentials increase, the C₂₊ FE continues to decrease to 39% at –0.75 V_{RHE} (Fig. 3b). Increasing the cathode potentials induces the further reduction of Cu₂O to metallic Cu. Since oxidative Cu species act as

the main active sites for C₂₊ products, the reduction in these active species on the catalyst surface results in a decrease in the selectivity for C₂₊ products. This indicates that *in situ* reduction of Cu₂O cannot enhance catalytic activity at higher cathodic potentials, possibly due to the inherent Cu₂O grain boundary structure's inability to stabilize active Cu⁺ species. Although plasma oxidation treatment (Ar/O₂) raises the oxidation state of Cu₂O, achieving a C₂₊ FE of 77.14% at low potential (–0.65 V_{RHE}), it still fails to stabilize active Cu⁺ species at higher potentials (–0.7 and –0.75 V_{RHE}), leading to decreased activity (Fig. 3b). However, for the Cu₂O–Ar/H₂ sample, the C₂₊ FE is lower than that of Cu₂O and Cu₂O–Ar/O₂ at –0.65 V_{RHE}, but at –0.7 V_{RHE}, the C₂₊ FE reaches 81.2% with a current density of ~100 mA cm^{–2}. Moreover, at higher potentials (–0.75 V_{RHE}), the C₂₊ FE of Cu₂O–Ar/H₂ also exceeds that of Cu₂O and Cu₂O–Ar/O₂ (Fig. 3b). This suggests that the Cu⁰/Cu⁺ interface structure and high density of oxygen vacancies obtained through plasma reduction treatment (Ar/H₂) can effectively stabilize active Cu species during ECR, enhancing C₂₊ selectivity. Considering the impact of plasma treatment on catalytic activity of C₂₊ products, a comparison is made with other plasma-treated catalysts in terms of C₂₊ FE (Fig. 3c and Table S2†). The results show that catalytic activity

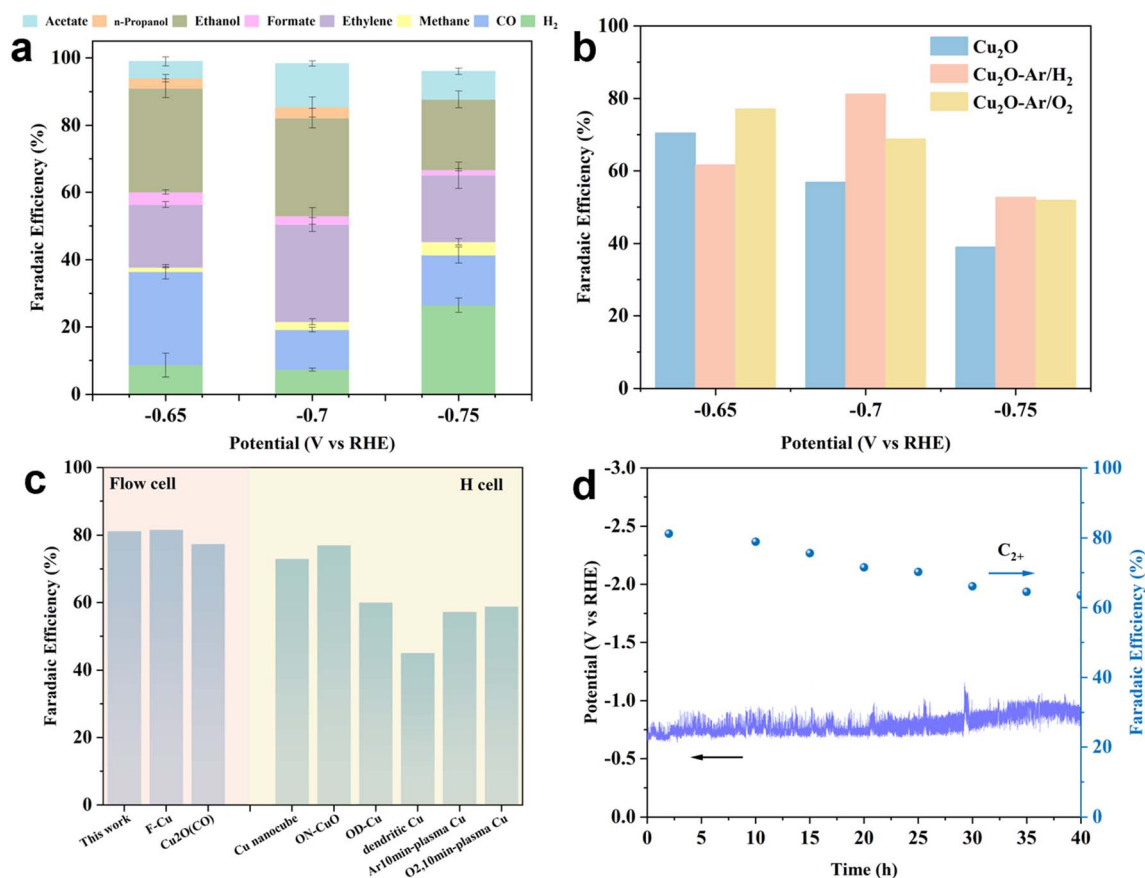


Fig. 3 ECR performance of the as-prepared catalysts. (a) The reduced product distribution of CO₂ for Cu₂O–Ar/H₂ at different cathodic potentials under ECR. (b) The FEs for C₂₊ products on the as-synthesized samples. (c) Comparisons of the FE values for C₂₊ products between Cu₂O–Ar/H₂ and other recently reported plasma-treated Cu-based catalysts. The summary of the specific ECR performance of catalysts is presented in Table S1.† (d) The stability test of Cu₂O–Ar/H₂ at a current density of 100 mA cm^{–2} using a flow cell.

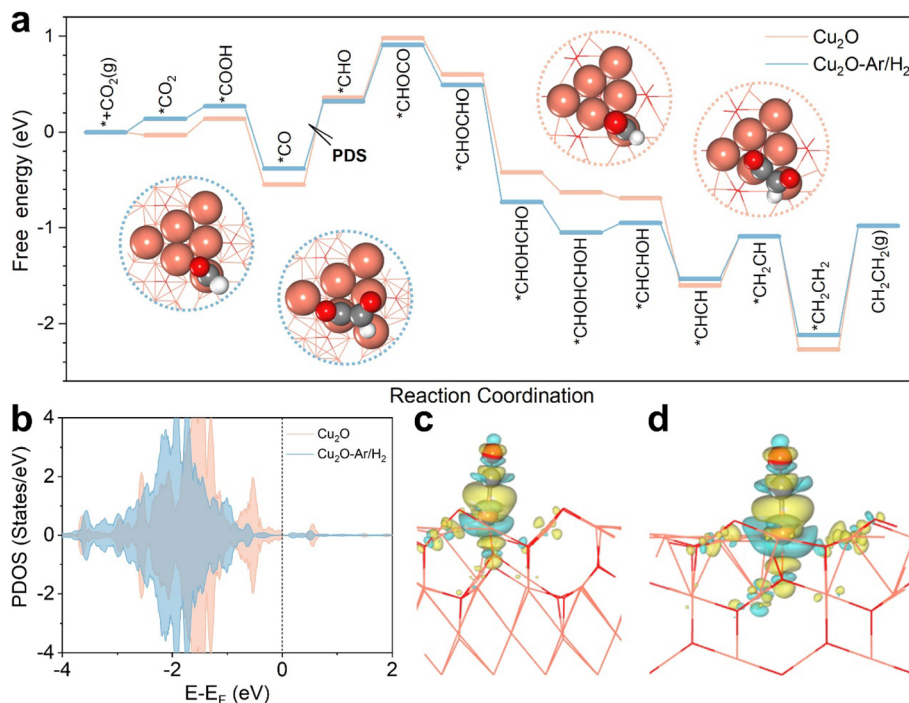


Fig. 4 DFT investigations. (a) Free energy profile of ethylene production on $\text{Cu}_2\text{O-Ar/H}_2$ and Cu_2O , including the $^*\text{CHO}$ and $^*\text{CHOCO}$ structures. (b) PDOS of the Cu-d states of vertex Cu atoms in $\text{Cu}_2\text{O-Ar/H}_2$ and Cu_2O . Charge density differences of $^*\text{CO}$ on (c) $\text{Cu}_2\text{O-Ar/H}_2$ and (d) Cu_2O with an isovalue of $0.001 \text{ e} \text{ \AA}^{-3}$, where yellow and cyan regions denote electron accumulation and depletion, respectively.

of $\text{Cu}_2\text{O-Ar/H}_2$ exceeds that of most plasma-treated samples, demonstrating excellent ECR performance in terms of the C_{2+} product pathway.

A long-term stability test was conducted to evaluate the practical applicability of the catalyst. Considering the C_{2+} product selectivity and industrial-relevant current densities, $\text{Cu}_2\text{O-Ar/H}_2$ was selected to run stability tests in a flow cell with 1 M KOH at a constant current of 100 mA cm^{-2} (Fig. 3d). The results show that the ECR system could operate stably for 40 h, with a gradual decrease in C_{2+} FE from an initial 81.2% to 63.5%. This indicates that $\text{Cu}_2\text{O-Ar/H}_2$ has significant potential for industrial-scale ECR to C_{2+} product conversion as it can be used as a standardized process.

3.3 DFT calculations

To better understand how interface structures and oxygen vacancies enhance the activity towards C_{2+} products, we conducted DFT calculations with ethylene as the representative C_{2+} product. As shown in Fig. S11,[†] there are Cu triangles due to oxygen vacancies, of which both vertex and edge Cu atoms can be active sites. The project density of states (PDOS) shows that the Cu-d states of vertex atoms are always closer to the Fermi level than those of edge atoms (Fig. S12[†]), so CO_2 adsorption begins on these sites. For ethylene production, the adsorbed $^*\text{CO}_2$ is reduced to $^*\text{CO}$ first and then hydrogenated to $^*\text{CHO}$ on vertex Cu atoms, and subsequently the C-C coupling occurs, $^*\text{CHO} + ^*\text{CO} \rightarrow ^*\text{CHOCO}$, on both vertex and edge Cu atoms (Fig. 4a). The C-C coupling step is always endothermic but is weaker than the hydrogenation of $^*\text{CO}$ to $^*\text{CHO}$, and the

potential-determining step (PDS) is thus $^*\text{CO} \rightarrow ^*\text{CHO}$, with the free energy changes of the PDS of 0.70 and 0.91 eV for $\text{Cu}_2\text{O-Ar/H}_2$ and Cu_2O , respectively. Fig. 4b shows the PDOS of vertex Cu atoms in $\text{Cu}_2\text{O-Ar/H}_2$ and Cu_2O , and we can find that the Cu-d states of $\text{Cu}_2\text{O-Ar/H}_2$ are more far to the Fermi level than those of Cu_2O , which leads to different adsorption strengths of $^*\text{CO}$. Electron accumulation between active Cu sites and the C atom of $^*\text{CO}$ can be found in the charge density difference plots (Fig. 4c and d), validating strong interactions between $^*\text{CO}$ and catalysts. The Bader charge analysis suggests that $0.10 |e|$ is transferred from $\text{Cu}_2\text{O-Ar/H}_2$ to $^*\text{CO}$, which is smaller than that on Cu_2O ($0.16 |e|$), in accordance with the more unactive Cu-d states of $\text{Cu}_2\text{O-Ar/H}_2$ shown in Fig. 4b. This leads to weaker $^*\text{CO}$ adsorption on $\text{Cu}_2\text{O-Ar/H}_2$ with $E_{\text{ads-CO}} = -1.58 \text{ eV}$, while $E_{\text{ads-CO}} = -1.83 \text{ eV}$ for Cu_2O . In short, multiple active sites induced by oxygen vacancies make the C-C coupling easier than the $^*\text{CO}$ hydrogenation and weaker $^*\text{CO}$ adsorption on $\text{Cu}_2\text{O-Ar/H}_2$ related to interface engineering makes the $^*\text{CO}$ hydrogenation easier than that on Cu_2O .

4 Conclusions

In summary, a facile, scalable, and standardized magnetron sputtering method combined with plasma surface treatment was developed to controllably construct high-activity catalysts for C_{2+} products. Cu_2O with rich grain boundaries, upon plasma reduction treatment, displays a well-defined Cu^0/Cu^+ interface structure with abundant oxygen vacancies. The enhanced activity stems from the synergistic interaction of the interface

structure and oxygen vacancies. Compared to the original Cu₂O and Cu₂O further treated with plasma oxidation, pre-plasma reduction treatment of Cu₂O effectively prevents the loss of active sites during *in situ* reduction of ECR. This work reveals the real active sites created by plasma treatment during the ECR process, effectively promoting the industrial-scale application of ECR.

Data availability

The authors declare that all data supporting this study are available within the paper and ESI† files. Source data are provided upon request.

Author contributions

Y. A. W. conceived and supervised the project. Z. T. co-supervised the project. C. V. S. and L. Z. led the DFT calculations. S. J. and Y. Z. carried out the catalyst's synthesis. L. W. conducted characterization and performance tests of catalysts. X. Y. and C. Q. conducted the DFT calculations. S. J. carried out the XAS measurements. N. C. provided advice for the XAFS measurements. L. W., X. Y., S. J., C. V. S., Z. C. T., and Y. A. W. wrote the manuscript. All authors made comments and revised the manuscript.

Conflicts of interest

All the authors declare no competing interests.

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